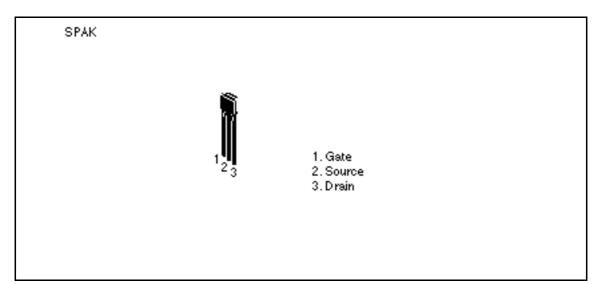
Silicon N-Channel MOS FET

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Application

VHF amplifier

Outline





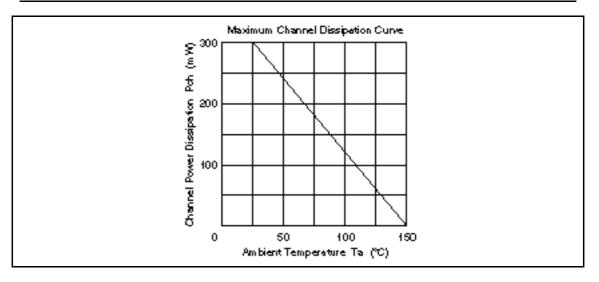
Absolute Maximum Ratings (Ta = 25° C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DS}	20	V
Gate to source voltage	V _{GSS}	±5	V
Drain current	I _D	30	mA
Gate current	l _G	±1	mA
Channel power dissipation	Pch	300	mW
Channel temperature	Tch	150	°C
Storage temperature	Tstg	–55 to +150	°C

Electrical Characteristics (Ta = 25° C)

Item	Symbol	Min	Тур	Max	Unit	Test conditions	
Drain to source breakdown voltage	$V_{(\text{BR})\text{DSX}}$	20	_	_	V	$I_{\rm D} = 100 \ \mu A, \ V_{\rm GS} = -4 \ V$	
Gate cutoff current	I _{GSS}	—	—	±20	nA	$V_{GS} = \pm 5 V, V_{DS} = 0$	
Drain current	I*1	4	—	12	mA	$V_{DS} = 10 V, V_{GS} = 0$	
Gate to source cutoff voltage	$V_{\text{GS(off)}}$	0	_	-2.0	V	$V_{\rm DS} = 10 \text{ V}, \text{ I}_{\rm D} = 10 \mu\text{A}$	
Forward transfer admittance	y _{fs}	8	14	—	mS	$V_{DS} = 10 \text{ V}, V_{GS} = 0, f = 1 \text{ kHz}$	
Input capacitance	Ciss	_	2.5	_	pF	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 0, \text{ f} = 1$ MHz	
Reverse transfer capacitance	Crss	_	0.03	—	pF	-	
Output capacitance	Coss	—	1.8	—	pF	$V_{DS} = 5 V, V_{GS} = 0, f = 1 MHz$	
Power gain	PG	_	30	_	dB	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 0,$ f = 100 MHz	
Noise figure	NF	—	2.0	_	dB	-	
Note: 1. The 2SK439 is grouped by I _{DSS} as follows.							
Grade D E		F					
I _{DSS} 4 to 8 6 t	:o 10	8 to 12					

See characteristic curves of 2SK359.



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Hitachi, Ltd. Semiconductor & IC DV. Nepon Bidg, 2-5-2, Ohte-mach, Chiyoda-ku, Tokyo 100, Japan Tet Tokyo (03, 3270-2111 Fax (03, 3270-5109

For Author in forms Ion write to : Hischi America, Ud Semiconductor & IC DV. 2000 Sierre Point Pertwey Briebene, CA. 94005-4835 U S.Å Tet 415-583-8300 Fax: 415-583-4207

Hischi Burope GmbH Bedronic Components Group Cartinertel Burope Danscher Streiße 3 D-85522 Fieldkirchen Minchen Tet 089-9 94 80-0 Fex 089-9 29 30 00 Hitschi Burope Ltd. Bedronic Components Div. Nothern Burope Headquerters Whitebrook Park Lower Cook hem Road Neidenhead Berkshire SL68YÅ Uhited Kingdon Tet 0628-585000 Fer: 0628-778322 Hitschi Asia Pte. Ltd 45 Collyer Quey \$20-00 Hitschi Tower Singspore 0404 Tet 535-2400 Fex: 535-4533

Hitschi Asia (Hong Kong) Ltd. Unit 705, North Towar, World Finance Cantre, Herbour City, Carton Road Taim Sha Tau, Kowloon Hong Kong Tet 27350218 Fax: 27306074

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